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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Connell et al.

Serial No.: 10/706,212

Filed: November 12, 2003

For: WAFER BACK SIDE COATING TO
BALANCE STRESS FROM PASSIVATION
LAYER ON FRONT OF WAFER AND BE
USED AS A DIE ATTACH ADHESIVE

VIA ELECTRONIC FILING
May 29, 2007

Confirmation No.: 6326

Examiner: N. Richards

Group Art Unit: 2815

Attorney Docket No.: 2269-5083.1US
(01-0428.01/US)

**AMENDMENT ACCOMPANYING REQUEST FOR CONTINUED EXAMINATION
AND IN RESPONSE TO FINAL REJECTION**

MAIL STOP AF
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

This amendment is in response to the final Office Action of April 11, 2007, whose initial period of response is set to expire on July 11, 2007.

Amendments to the Specification begin on page 2 of this paper.

Amendments to the Claims are reflected in the listing of claims which begins on page 3 of this paper.

Remarks/Arguments begin on page 9 of this paper.